

[Order](http://www.ti.com/product/INA1650-Q1?dcmp=dsproject&hqs=sandbuy&#samplebuy) Now



# **INA165x-Q1 SoundPlus™ High Common-Mode Rejection Line Receivers**

**Technical [Documents](http://www.ti.com/product/INA1650-Q1?dcmp=dsproject&hqs=td&#doctype2)** 

## <span id="page-0-1"></span>**1 Features**

- AEC-Q100 qualified for automotive applications – Temperature grade 1:  $-40^{\circ}$ C to +125 $^{\circ}$ C, T<sub>A</sub>
- High common-mode rejection: 91 dB (typical)
- High input impedance: 1 MΩ differential
- Ultra-low noise:  $-104.7$  dBu, unweighted
- Ultra-low total harmonic distortion + noise: –119 dB THD+N (20 dBu, 22-kHz bandwidth)
- Short-circuit protection
- Integrated EMI filters
- Wide supply range:  $\pm 2.25$  V to  $\pm 12$  V
- Available in small 14-Pin TSSOP package

## <span id="page-0-2"></span>**2 Applications**

- Cabin microphone preamplifiers
- Infotainment systems
- Audio input circuitry
- Line drivers
- <span id="page-0-3"></span>External audio power amplifiers

<span id="page-0-0"></span>

## **Simplified Internal Schematic**

## **3 Description**

Tools & [Software](http://www.ti.com/product/INA1650-Q1?dcmp=dsproject&hqs=sw&#desKit)

The INA1650-Q1 dual-channel and INA1651-Q1 single-channel (INA165x-Q1) SoundPlus™ audio line receivers achieve an extremely high common-mode rejection ratio (CMRR) of 91 dB while maintaining an ultra-low THD+N of –119 dB at 1 kHz for 20-dBu signal levels. Unlike other line receiver products, the<br>INA165x-Q1 CMRR is characterized over INA165x-Q1 CMRR is characterized over temperature and tested in production to deliver consistent performance in a wide variety of applications.

Support & **[Community](http://www.ti.com/product/INA1650-Q1?dcmp=dsproject&hqs=support&#community)** 

 $22$ 

The INA165x-Q1 devices operate over a very-widesupply range of  $\pm 2.25$  V to  $\pm 12$  V. In addition to the line-receiver channels, a buffered midsupply reference output is included to allow the INA165x-Q1 to be configured for dual-supply or single-supply applications. The midsupply output can be used as a bias voltage for other analog circuitry in the signal chain.

The INA1650-Q1 features a unique internal layout for lowest crosstalk and freedom from interactions between channels, even when overdriven or overloaded.





(1) For all available packages, see the package option addendum at the end of the data sheet.



#### **CMRR Histogram (5746 Channels)**

An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, **44** intellectual property matters and other important disclaimers. PRODUCTION DATA.

2

# **Table of Contents**





## <span id="page-1-0"></span>**4 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.



## Changes from Original (August 2017) to Revision A **Page** 2017) **Page**

• Recommended supply range of the INA1650-Q1 was reduced from 36 V to 24 V. All references to 36 V operation in text, graphs, and circuit diagrams, was removed or modified to reflect the 24 V maximum supply. ..................................... [1](#page-0-3)





## <span id="page-2-0"></span>**5 Pin Configuration and Functions**



#### **Pin Functions: INA1650-Q1**







#### **Pin Functions: INA1651-Q1**



4

*[Submit Documentation Feedback](http://www.go-dsp.com/forms/techdoc/doc_feedback.htm?litnum=SBOS772C&partnum=INA1650-Q1)* Copyright © 2017–2019, Texas Instruments Incorporated



## <span id="page-4-0"></span>**6 Specifications**

## <span id="page-4-1"></span>**6.1 Absolute Maximum Ratings**

over operating free-air temperature range (unless otherwise noted) $<sup>(1)</sup>$ </sup>



(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Short-circuit to  $V_S$  / 2 (ground in symmetrical dual supply setups), one amplifier per package.

## <span id="page-4-2"></span>**6.2 ESD Ratings**

<span id="page-4-5"></span>

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

## <span id="page-4-3"></span>**6.3 Recommended Operating Conditions**

over operating free-air temperature range (unless otherwise noted)



## <span id="page-4-4"></span>**6.4 Thermal Information**



(1) For more information about traditional and new thermal metrics, see the *[Semiconductor and IC Package Thermal Metrics](http://www.ti.com/lit/pdf/spra953)* application [report.](http://www.ti.com/lit/pdf/spra953)

Copyright © 2017–2019, Texas Instruments Incorporated *[Submit Documentation Feedback](http://www.go-dsp.com/forms/techdoc/doc_feedback.htm?litnum=SBOS772C&partnum=INA1650-Q1)*

SBOS772C –AUGUST 2017–REVISED MAY 2019 **[www.ti.com](http://www.ti.com)**

**NSTRUMENTS** 

**EXAS** 

## <span id="page-5-0"></span>**6.5 Electrical Characteristics:**

at T<sub>A</sub> = 25°C, V<sub>S</sub> = ±2.25 V to ±12 V, V<sub>CM</sub> = V<sub>OUT</sub> = midsupply, and R<sub>L</sub> = 2 k $\Omega$  (unless otherwise noted)



(1) Full-power bandwidth = SR / ( $2\pi \times V_P$ ), where SR = slew rate.<br>(2) Specified by design and characterization.

6

*[Submit Documentation Feedback](http://www.go-dsp.com/forms/techdoc/doc_feedback.htm?litnum=SBOS772C&partnum=INA1650-Q1)* Copyright © 2017–2019, Texas Instruments Incorporated



## **Electrical Characteristics: (continued)**

at  $T_A = 25^{\circ}$ C,  $V_S = \pm 2.25$  V to  $\pm 12$  V,  $V_{CM} = V_{OUT}$  = midsupply, and  $R_L = 2$  k $\Omega$  (unless otherwise noted)

<b>PARAMETER</b>			<b>TEST CONDITIONS</b>	<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>	
<b>INPUT IMPEDANCE</b>								
	Differential			850	1000	1150	$k\Omega$	
	Common-mode			212.5	250	287.5	$k\Omega$	
	Input resistance mismatch				0.01%	0.25%		
<b>SUPPLY DIVIDER CIRCUIT</b>								
	Nominal output voltage				$[(V+) + (V-)]/2$		V	
	Output voltage offset	$VMD(IN) = ((V+) + (V-) / 2)$		2		$\overline{4}$	mV	
	Input impedance	$VMD(IN)$ pin, $f = 1$ kHz		250			$k\Omega$	
	Output resistance	VMID(OUT) pin		0.35			$\Omega$	
	Output voltage noise	20 Hz to 20 kHz, $C_{MID} = 1 \mu F$			1.56		$\mu V_{RMS}$	
	Output capacitive load limit	Phase Margin > 45°, R <sub>ISO</sub> = 0 $\Omega$			150		pF	
<b>OUTPUT</b>								
$V_{\Omega}$	Voltage output swing from rail	Positive rail	$R_L = 2 k\Omega$		350		mV	
			$R_1 = 600 \Omega$		1100			
		Negative rail	$R_L = 2 k\Omega$		430			
			$R_1 = 600 \Omega$		1300			
$Z_{OUT}$	Output impedance	f ≤ 100 kHz, $I_{OUT}$ = 0 A		$\leq 1$			$\Omega$	
$I_{SC}$	Short-circuit current	$V_S = \pm 12$ V			±75		mA	
$C_{LOAD}$	Capacitive load drive			See Figure 19			pF	
<b>POWER SUPPLY</b>								
Ιo	Quiescent current	$I_{OIII} = 0$ A, INA1651-Q1		4.6	6	6.9	mA	
			$T_A = -40$ °C to 125°C <sup>(2)</sup>			8		
		$I_{\text{OUT}} = 0$ A, INA1650-Q1		8	10.5	12		
			$T_A = -40$ °C to 125°C <sup>(2)</sup>			14		

SBOS772C –AUGUST 2017–REVISED MAY 2019 **[www.ti.com](http://www.ti.com)**

**STRUMENTS** 

**EXAS** 

## **6.6 Typical Characteristics**

at T<sub>A</sub> = 25°C, V<sub>S</sub> = ±12 V, V<sub>CM</sub> = V<sub>OUT</sub> = midsupply, and R<sub>L</sub> = 2 k $\Omega$  (unless otherwise noted)

<span id="page-7-0"></span>

8



## **Typical Characteristics (continued)**



at T<sub>A</sub> = 25°C, V<sub>S</sub> = ±12 V, V<sub>CM</sub> = V<sub>OUT</sub> = midsupply, and R<sub>L</sub> = 2 k $\Omega$  (unless otherwise noted)

#### **[INA1650-Q1](http://www.ti.com/product/ina1650-q1?qgpn=ina1650-q1), [INA1651-Q1](http://www.ti.com/product/ina1651-q1?qgpn=ina1651-q1)** SBOS772C –AUGUST 2017–REVISED MAY 2019 **[www.ti.com](http://www.ti.com)**

## **Typical Characteristics (continued)**



at T<sub>A</sub> = 25°C, V<sub>S</sub> = ±12 V, V<sub>CM</sub> = V<sub>OUT</sub> = midsupply, and R<sub>L</sub> = 2 k $\Omega$  (unless otherwise noted)



## **Typical Characteristics (continued)**

at T<sub>A</sub> = 25°C, V<sub>S</sub> = ±12 V, V<sub>CM</sub> = V<sub>OUT</sub> = midsupply, and R<sub>L</sub> = 2 kΩ (unless otherwise noted)

<span id="page-10-0"></span>

SBOS772C –AUGUST 2017–REVISED MAY 2019 **[www.ti.com](http://www.ti.com)**



## **Typical Characteristics (continued)**

at T<sub>A</sub> = 25°C, V<sub>S</sub> = ±12 V, V<sub>CM</sub> = V<sub>OUT</sub> = midsupply, and R<sub>L</sub> = 2 kΩ (unless otherwise noted)



*[Submit Documentation Feedback](http://www.go-dsp.com/forms/techdoc/doc_feedback.htm?litnum=SBOS772C&partnum=INA1650-Q1)* Copyright © 2017–2019, Texas Instruments Incorporated



### **Typical Characteristics (continued)**



#### **[INA1650-Q1](http://www.ti.com/product/ina1650-q1?qgpn=ina1650-q1), [INA1651-Q1](http://www.ti.com/product/ina1651-q1?qgpn=ina1651-q1)** SBOS772C –AUGUST 2017–REVISED MAY 2019 **[www.ti.com](http://www.ti.com)**

**EXAS NSTRUMENTS** 

## **Typical Characteristics (continued)**





## <span id="page-14-0"></span>**7 Detailed Description**

## <span id="page-14-1"></span>**7.1 Overview**

The INA165x-Q1 family combines high-performance audio operational amplifier cores with high-precision resistor networks to provide exceptional audio performance and rejection of noise that may be externally coupled into the audio signal path. The two line-receiver channels of the INA1650-Q1, and the single line receiver channel of the INA1651-Q1, use an instrumentation amplifier topology with a fixed unity gain to provide high input impedance and a high common-mode rejection ratio (CMRR). Unlike other line receiver products that use a simple fourresistor difference amplifier topology, the INA165x-Q1 topology provides excellent CMRR even with mismatched source impedances.

## <span id="page-14-2"></span>**7.2 Functional Block Diagram**



**[INA1650-Q1](http://www.ti.com/product/ina1650-q1?qgpn=ina1650-q1), [INA1651-Q1](http://www.ti.com/product/ina1651-q1?qgpn=ina1651-q1)** SBOS772C –AUGUST 2017–REVISED MAY 2019 **[www.ti.com](http://www.ti.com)**

#### <span id="page-15-0"></span>**7.3 Feature Description**

#### **7.3.1 Audio Signal Path**

[Figure 39](#page-15-1) highlights the basic elements present in the audio signal pathway of the INA165x-Q1 line receivers. The primary elements are input biasing resistors, electromagnetic interference (EMI) filtering, input buffers, and a difference amplifier. The primary role of an audio line receiver is to convert a differential input signal into a singleended output signal while rejecting noise that is common to both inputs (common-mode noise). The difference amplifier (which consists of an op amp and four matched 10-kΩ resistors) accomplishes this task. The basic transfer function of the circuit is shown in [Equation 1](#page-15-2):

 $10 k\Omega$   $10 k\Omega$ 

<span id="page-15-2"></span>
$$
V_{OUT} = (V_{IN+} - V_{IN-}) + V_{REF}
$$

 $IN + C$ 

Resistors

500  $k\Omega$ ij 뷰 + COM O o out 井川 ± 500  $k\Omega$ IN- $10 k\Omega$   $10 k\Omega$ EMI **Difference** Input Input Filtering Biasing Buffers Amplifier

л Ti



**Figure 39. INA165x-Q1 Audio Signal Path (Single Channel Shown)**

<span id="page-15-1"></span>The input buffers prevent external resistances (such as those from the PCB, connectors, or cables) from ruining the precise matching of the internal 10-kΩ resistors that degrade the high common-mode rejection of the difference amplifier. As is typical of many amplifiers, a small bias current flows into or out of the buffer amplifier inputs. This current must flow to a common potential for the buffer to function properly. The input biasing resistors provide an internal pathway for this current to the COM pin. The COM pin connects to ground in a dualsupply system, or to the output of the internal supply divider, VMID(OUT), in single-supply applications. Finally, EMI filtering is added to the input buffers to prevent high-frequency interference signals from propagating through the audio signal pathway.



 $\circ$  REF





#### **Feature Description (continued)**

#### **7.3.2 Supply Divider**

The INA165x-Q1 have an integrated supply-divider circuit that biases the input common-mode voltage and output reference voltage to the halfway point between the applied power supply voltages. The nominal output voltage of the supply divider circuit is shown in [Equation 2](#page-16-0):

$$
V_{MID(OUT)} = \frac{VCC + VEE}{2}
$$

(2)

<span id="page-16-0"></span>[Figure 40](#page-16-1) illustrates the internal topology of the supply-divider circuit. The supply divider consists of two 500-kΩ resistors connected between the VCC and VEE pins of the INA165x-Q1. The noninverting input of a buffer amplifier is connected to the midpoint of the voltage divider that is formed by the 500-kΩ resistors. The buffer amplifier provides a low-impedance output that is required to bias the REF pins without degrading the CMRR. For dual-supply applications where the supply divider circuit is not used, no connection is required for the VMID(IN) or VMID(OUT) pins.



Copyright © 2016, Texas Instruments Incorporated

<span id="page-16-1"></span>**Figure 40. Internal Supply Divider Circuit**

**EXAS NSTRUMENTS** 

## **Feature Description (continued)**

### **7.3.3 EMI Rejection**

The INA165x-Q1 use integrated electromagnetic interference (EMI) filtering to reduce the effects of EMI from sources (such as wireless communications) and densely-populated boards with a mix of analog signal-chain and digital components. The INA165x-Q1 devices are specifically designed to minimize susceptibility to EMI by incorporating an internal low-pass filter. Depending on the end-system requirements, additional EMI filters may be required near the signal inputs of the system; as well as incorporating known good practices, such as using short traces, low-pass filters, and damping resistors combined with parallel and shielded signal routing. Texas Instruments developed a method to accurately measure the immunity of an amplifier over a broad frequency spectrum, extending from 10 MHz to 6 GHz. This method uses an EMI rejection ratio (EMIRR) to quantify the ability of the INA165x-Q1 to reject EMI. [Figure 41](#page-17-0) and [Figure 42](#page-17-0) show the INA165x-Q1 EMIRR graph for both differential and common-mode EMI rejection across this frequency range. [Table 1](#page-17-1) shows the EMIRR values for the INA165x-Q1 at frequencies commonly encountered in real-world applications. Applications listed in [Table 1](#page-17-1) can be centered on or operated near the particular frequency shown.

<span id="page-17-0"></span>

<span id="page-17-1"></span>

#### **Table 1. EMIRR for Frequencies of Interest**

*[Submit Documentation Feedback](http://www.go-dsp.com/forms/techdoc/doc_feedback.htm?litnum=SBOS772C&partnum=INA1650-Q1)* Copyright © 2017–2019, Texas Instruments Incorporated



#### **[www.ti.com](http://www.ti.com)** SBOS772C –AUGUST 2017–REVISED MAY 2019

#### **7.3.4 Electrical Overstress**

Designers often ask questions about the capability of an amplifier to withstand electrical overstress. These questions typically focus on the device inputs, but can involve the supply voltage pins or the output pin. Each of

**[INA1650-Q1,](http://www.ti.com/product/ina1650-q1?qgpn=ina1650-q1) [INA1651-Q1](http://www.ti.com/product/ina1651-q1?qgpn=ina1651-q1)**

these different pin functions have electrical stress limits determined by the voltage breakdown characteristics of the particular semiconductor fabrication process and specific circuits connected to the pin. Additionally, internal electrostatic discharge (ESD) protection is built into these circuits to protect them from accidental ESD events, both before and during product assembly. A good understanding of basic ESD circuitry and the relevance of circuitry to an electrical overstress event is helpful. [Figure 43](#page-18-1) illustrates the ESD circuits contained in the INA165x-Q1. The ESD protection circuitry involves several current-steering diodes that are connected from the input and output pins, and routed back to the internal power-supply lines. This protection circuitry is intended to remain inactive during normal circuit operation. The input pins of the INA165x-Q1 are protected with internal diodes that are connected to the power-supply rails. These diodes clamp the applied signal to prevent the input circuitry from damage. If the input signal voltage exceeds the power supplies by more than 0.3 V, limit the input signal current to less than 10 mA to protect the internal clamp diodes. A series input resistor can typically limit the current. Some signal sources are inherently current-limited and do not require limiting resistors.



**Figure 43. INA165x-Q1 Internal ESD Protection Circuitry (Single Channel and Supply-Divider Shown for Simplicity)**

#### <span id="page-18-1"></span>**7.3.5 Thermal Shutdown**

If the junction temperature of the INA165x-Q1 exceed approximately 170°C, a thermal shutdown circuit disables the amplifier to protect the device from damage. The amplifier is automatically re-enabled after the junction temperature falls to less than the shutdown threshold temperature. If the condition that caused excessive power dissipation is not removed, the amplifier oscillates between the shutdown and enabled state until the output fault is corrected.

## <span id="page-18-0"></span>**7.4 Device Functional Modes**

#### **7.4.1 Single-Supply Operation**

The INA165x-Q1 can be used on single power supplies ranging from 4.5 V to 24 V. Use the COM and REF pins to level shift the internal voltages into a linear operating condition. Ideally, connecting the REF and COM pins to a midsupply potential, such as the VMID(OUT) pin, avoids saturating the output of the internal amplifiers.

Copyright © 2017–2019, Texas Instruments Incorporated *[Submit Documentation Feedback](http://www.go-dsp.com/forms/techdoc/doc_feedback.htm?litnum=SBOS772C&partnum=INA1650-Q1)*

**FXAS NSTRUMENTS** 

## <span id="page-19-0"></span>**8 Application and Implementation**

#### **NOTE**

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### <span id="page-19-1"></span>**8.1 Application Information**

#### **8.1.1 Input Common-Mode Range**

The linear input voltage range of the INA165x-Q1 input circuitry extends from 350 mV inside the negative supply voltage to 2 V below the positive supply, and maintains 85-dB (minimum) common-mode rejection throughout this range. The INA165x-Q1 operates over a wide range of power supplies and  $V_{REF}$  configurations; providing a comprehensive guide to common-mode range limits for all possible conditions is impractical. The common-mode range for most operating conditions is best calculated using the [INA common-mode range calculating tool.](http://www.ti.com/tool/ina-cmv-calc)

#### <span id="page-19-3"></span>**8.1.2 Common-Mode Input Impedance**

The high CMRR of many line receivers can degrade by impedance mismatches in the system. [Figure 44](#page-19-2) shows a common-mode noise source ( $V_{CM}$ ) connected to both inputs of a single channel of the INA165x-Q1. An external parasitic resistance  $(R_{EXT})$  represents the mismatch in impedances between the common-mode noise source and the inputs of the INA165x-Q1. This mismatched impedance may be due to PCB layout, connectors, cabling, passive component tolerances, or the circuit topology. The presence of  $R_{EXT}$  in series with the IN+ input degrades the overall CMRR of the system because the voltage at IN+ is no longer equal to the voltage at IN–. Therefore, a portion of the common-mode noise converts to a differential signal and passes to the output.



Copyright © 2016, Texas Instruments Incorporated

#### <span id="page-19-2"></span>**Figure 44. A Single Channel of the INA165x-Q1 Shown With Source Impedance Mismatch (REXT) and Optional Resistor (R<sub>COM</sub>)**

While the INA165x-Q1 is significantly more resistant to these effects than typical line receivers, connecting a resistor ( $R_{COM}$ ) from the COM pin to the system ground further improves CMRR performance. [Figure 45](#page-20-0) shows the CMRR of the INA165x-Q1 (typical CMRR of 92 dB) for increasing source impedance mismatches. If the COM pin is connected directly to ground (R<sub>COM</sub> equal to 0  $\Omega$ ), a 20- $\Omega$  source impedance mismatch degrades the CMRR from 92 dB to 83.7 dB. However, if  $R_{COM}$  has a value of 1 M $\Omega$ , the CMRR only degrades to 89.6 dB, which is an improvement of approximately 6 dB.



### **Application Information (continued)**



Figure 45. CMRR vs Source Impedance Mismatch for Different R<sub>COM</sub> Values

<span id="page-20-0"></span>R<sub>COM</sub> does not need to be a high-precision resistor with a very tight tolerance. Low-cost 5% or 1% resistors can be used with no degradation in overall performance. The addition of  $R_{COM}$  does not increase the noise of the audio signal path.

In single-supply systems where AC coupling is used at the inputs of the INA165x-Q1, adding  $R_{COM}$  lengthens the start-up time of the circuit. The input AC-coupling capacitors are charged to the midsupply voltage through the R<sub>COM</sub> resistor, which may take a substantial amount of time if R<sub>COM</sub> has a large value (such as 1 MΩ). Do not use  $R_{COM}$  in these systems if start-up time is a concern. In dual-supply systems with input AC-coupling capacitors, the capacitor voltage does not need to be charged to a midsupply point, because the capacitor voltage settles to ground by default. Therefore, R<sub>COM</sub> does not increase start-up time in dual-supply systems.

#### **8.1.3 Start-Up Time in Single-Supply Applications**

The internal supply divider of the INA165x-Q1 is constructed using two 500-kΩ resistors connected in series between the VCC and VEE pins. These resistors are matched on-chip to provide a reference voltage that is exactly one half of the power supply voltage. Noise from the power supplies and thermal noise from the resistors degrades the overall audio performance of the INA165x-Q1 if allowed to enter the signal path. Therefore, TI recommends a filter capacitor  $(C_F)$  is connected to the VMID(IN) pin, as shown in [Figure 46](#page-20-1) The C<sub>F</sub> capacitor forms a low-pass filter with the internal 500-kΩ resistors. Noise above the corner frequency of this filter is passed to ground and is removed from the audio signal path. The corner frequency of the filter is shown in [Equation 3](#page-20-2):

<span id="page-20-2"></span><span id="page-20-1"></span>



Copyright © 2016, Texas Instruments Incorporated

**Figure 46. Connect a Capacitor (CF) to the VMID(IN) Pin to Reduce Noise from the Voltage Divider**

Copyright © 2016, Texas Instruments Incorporated

**Figure 47. A Zener Diode (ZD1) Connected to the Positive Supply Can Decrease Start-Up Time**

(3)



(4)

#### **Application Information (continued)**

When power is applied to the INA165x-Q1, the filter capacitor (C<sub>F</sub>) charges through the internal 500-kΩ resistors. If the C<sub>F</sub> capacitor has a large value, the time required for  $V_{MID(OUT)}$  to reach the final midsupply voltage may be extensive. Adding a zener diode from the VMID(IN) pin to the positive power supply (as shown in [Figure 47](#page-20-1)) reduces this time. The zener voltage must be slightly greater than one half of the power supply voltage.

Using large AC-coupling capacitors increases the start-up time of the line receiver circuit in single-supply applications. When power is applied, the AC-coupling capacitors begin to charge to the midsupply voltage applied to the COM pin through a current flowing through the input resistors as shown in [Figure 48](#page-21-0). The INA165x-Q1 functions properly when the input common-mode voltage (and the capacitor voltage) is within the specified range. The time required for the input common-mode voltage to reach 98% of the final value is shown in [Equation 4:](#page-21-1)

<span id="page-21-1"></span>
$$
t_{98\%} = 4 \cdot R \cdot C_{IN} = 4 \cdot 500 \ k\Omega \cdot C_{IN}
$$



Copyright © 2016, Texas Instruments Incorporated

#### **Figure 48. AC-Coupling Capacitors Charge to the Mid-Supply Voltage Through the Input Resistors**

#### <span id="page-21-0"></span>**8.1.4 Input AC Coupling**

<span id="page-21-2"></span>The signal path in most audio systems is typically AC-coupled to avoid the propagation of DC voltages, which can potentially damage loudspeakers or saturate power amplifiers. The capacitor values must be selected to pass the desired bandwidth of audio signals. The high-pass corner frequency is calculated with [Equation 5:](#page-21-2)

$$
f_{C} = \frac{1}{2 \cdot \pi \cdot (2 \cdot R_{IN}) \cdot C_{IN/2}} = \frac{1}{2 \cdot \pi \cdot R_{IN} \cdot C_{IN}}
$$
\n(5)



Copyright © 2016, Texas Instruments Incorporated

#### **Figure 49. AC-Coupling Capacitors Form a High-Pass Filter With INA165x-Q1 Input Resistors**



### **Application Information (continued)**

Although the input resistors of the INA165x-Q1 are matched typically within 0.01%, large capacitors are usually mismatched. The mismatch in the values of the AC-coupling capacitors causes the corner frequencies at the two signal inputs (IN+ and IN–) to be different, which can degrade CMRR at low frequency. For this reason, TI recommends placing the high-pass corner frequency well below the audio bandwidth and to use a resistor in series with the COM pin (R<sub>COM</sub>), as shown in [Figure 44](#page-19-2) if possible. See the *[Common-Mode Input Impedance](#page-19-3)* section for more information on placing a resistor in series with the COM pin. [Figure 50](#page-22-0) shows the effect of a 5% mismatch in the values of the input AC-coupling capacitors with and without an  $R_{COM}$  resistor. Comparing CMRR at 100 Hz: 1-µF AC-coupling capacitors with a 5% mismatch degrade the CMRR to 75 dB, while 10-µF capacitors and a 1-M $\Omega$  R<sub>COM</sub> resistor shows 92 dB of CMRR.



**Figure 50. CMRR Degradation Due to a 5% Mismatch in AC-Coupling Capacitors**

#### <span id="page-22-0"></span>**8.1.5 Supply Divider Capacitive Loading**

<span id="page-22-1"></span>The VMID(OUT) pin of the INA165x-Q1 is stable with capacitive loads up to 150 pF. An isolation resistor ( $R_{\rm ISO}$  in [Figure 51\)](#page-22-1), must be used if capacitive loads larger than 150 pF are connected to the VMID(OUT) pin. [Figure 51](#page-22-1) shows the recommended configuration of an isolation resistor in series with the capacitive load. The REF pins of the INA165x-Q1 must connect directly to the VMID(OUT) pin before the isolation resistor. Any resistance placed between the VMID(OUT) pin and the reference pins degrades the CMRR of the device. [Figure 52](#page-22-2) shows the recommended value for the isolation resistor for increasing capacitive loads.



Copyright © 2016, Texas Instruments Incorporated

#### <span id="page-22-2"></span>**Figure 51. Place an Isolation Resistor Between the VMID(OUT) Pin and Large Capacitive Loads**



## **Application Information (continued)**



**Figure 52. Recommended Isolation Resistor Value vs Capacitive Load**



### <span id="page-24-0"></span>**8.2 Typical Applications**

The low noise and distortion of the INA165x-Q1 make the devices an excellent choice for a variety of applications in professional and consumer audio products. However, these same performance metrics make the INA165x-Q1 useful for industrial, test and measurement, and data-acquisition applications. The examples shown here are possible applications where the INA165x-Q1 provides exceptional performance.

#### **8.2.1 Line Receiver for Differential Audio Signals in a Split-Supply System**

The INA165x-Q1 are designed to require a minimum number of external components to achieve data sheet-level performance in audio line-receiver applications. [Figure 53](#page-24-1) shows the INA165x-Q1 used as a differential audio line receiver in split-supply systems that are common in many audio applications. The line receiver recovers a differential audio signal that may have been affected by significant common-mode noise.



<span id="page-24-1"></span>**Figure 53. INA1650-Q1 Device Used as a Line Receiver for Differential Audio Signals in a Split-Supply System**

Texas **INSTRUMENTS** 

### **Typical Applications (continued)**

## *8.2.1.1 Design Requirements*

- Power supply voltage: ±12 V
- Frequency response:  $< 0.1$  dB deviation from 20 Hz to 20 kHz
- Common-mode rejection ratio: > 80 dB at 1 kHz
- THD+N: < –100 dB (4-dBu input signal, 1-kHz fundamental, 90-kHz measurement bandwidth)

## *8.2.1.2 Detailed Design Procedure*

The passive components shown in [Figure 53](#page-24-1) are selected using the information given in the *[Application](#page-19-1) [Information](#page-19-1)* and *[Layout Guidelines](#page-29-2)* sections. All 10-µF input ac-coupling capacitors (C1, C2, C3, and C4) maximize the CMRR performance at low frequency, as shown in [Figure 50.](#page-22-0) The high-pass corner frequency for input signals meets the design requirement for frequency response, as [Equation 6](#page-25-0) shows:

$$
f_C = \frac{1}{2 \cdot \pi \cdot R_{IN} \cdot C_{IN}} = \frac{1}{2 \cdot \pi \cdot (500 \text{ k}\Omega) \cdot (10 \text{ }\mu\text{F})} = 0.032 \text{ Hz}
$$
\n(6)

<span id="page-25-0"></span>The 1-M $\Omega$  R<sub>COM</sub> resistors (R3 and R4) further improve CMRR performance at low frequency. Resistors R1, R2, R4, and R5 provide a discharge pathway for the ac-coupling capacitors in the event that audio equipment with a dc offset voltage is connected to the inputs of the circuit. These resistors are optional and may degrade the CMRR performance with mismatches in source impedance. Finally, capacitors C5, C6, C7, and C8 provide a low-impedance pathway for power supply noise to pass to ground rather than interfering with the audio signal. No connection is necessary on the VMID(IN) and VMID(OUT) pins because the supply-divider circuit is not used in this particular application.

### *8.2.1.3 Application Curves*

[Figure 54](#page-26-0) through [Figure 59](#page-26-1) illustrate the measured performance of the line receiver circuit. [Figure 54](#page-26-0) shows the measured frequency response. The gain of the circuit is 0 dB as expected with 0.1-dB magnitude variation at 10 Hz. The measured CMRR of the circuit [\(Figure 55\)](#page-26-0) at 1 kHz equals 94 dB without any source impedance mismatch. Adding a 10- $\Omega$  source impedance mismatch degrades the CMRR at 1 kHz to 92 dB. The high-frequency degradation of CMRR shown in [Figure 55](#page-26-0) for the 10- $\Omega$  source impedance mismatch cases is due to the capacitance of the cables used for the measurement. The total harmonic distortion plus noise (THD+N) is plotted over frequency in [Figure 56.](#page-26-2) For a 4-dBu (1.23  $V_{RMS}$ ) input signal level, the THD+N remains flat at -101.6 dB (0.0008%) over the measured frequency range. Increasing the signal level to 20 dBu further decreases the THD+N to –113.2 dB (0.00022%) at 1 kHz, but the THD+N rises to greater than 7 kHz. Measuring the THD+N vs output amplitude ([Figure 57](#page-26-2)) at 1 kHz shows a constant downward slope until the noise floor of the audio analyzer is reached at 5  $V_{RMS}$ . The constant downward slope indicates that noise from the device dominates THD+N at this frequency instead of distortion harmonics. [Figure 58](#page-26-1) and [Figure 59](#page-26-1) confirm this conclusion. For a 4–dBu signal level, the second harmonic is barely visible above the noise floor at –140 dBu. Increasing the signal level to 20 dBu produces distortion harmonics above the noise floor. The largest harmonic in this case is the second at the second second at the second second

–111.2 dBu, or –131.2 dB relative to the fundamental.



## **Typical Applications (continued)**

<span id="page-26-2"></span><span id="page-26-1"></span><span id="page-26-0"></span>

Texas **INSTRUMENTS** 

## **Typical Applications (continued)**

#### **8.2.2 Two-Channel Microphone Input for Automotive Infotainment Systems**

The high CMRR, low-noise, and ease-of-use in single supply applications make the INA165x-Q1 an excellent choice for applications in automotive infotainment systems. [Figure 60](#page-27-0) illustrates a high-CMRR input circuit for incabin microphones used for hands-free phone systems. The microphones are connected with matched bias resistors, R<sub>BIAS</sub>, to preserve the high-CMRR performance of the INA165x-Q1. The exact value of the microphone bias voltage,  $V_{BIAS}$ , and the R<sub>BIAS</sub> resistors depends on the particular microphones used. Bandwidth-limiting the audio signal to the range of frequencies for speech is common in hands-free systems. As shown in [Figure 60,](#page-27-0) all filtering components are placed at the output of the INA165x-Q1 rather than the input to preserve high CMRR. The values shown in [Figure 60](#page-27-0) limit the signal bandwidth to approximately 100 Hz to 10 kHz.



<span id="page-27-0"></span>**Figure 60. Two-channel Microphone Input for Automotive Infotainment Systems**

*[Submit Documentation Feedback](http://www.go-dsp.com/forms/techdoc/doc_feedback.htm?litnum=SBOS772C&partnum=INA1650-Q1)* Copyright © 2017–2019, Texas Instruments Incorporated



#### **Typical Applications (continued)**

#### **8.2.3 TRS Audio Interface in Single-Supply Applications**

The INA165x-Q1 can be used for auxiliary audio inputs that may use a tip-ring-sleeve (TRS) connector where both audio channels share a common ground connection. [Figure 61](#page-28-0) shows the INA1650-Q1 configured as a line receiver for a TRS interface to remove common-mode noise on the sleeve connection.



<span id="page-28-0"></span>**Figure 61. TRS Audio Interface in Single-Supply Applications**



## <span id="page-29-0"></span>**9 Power Supply Recommendations**

The INA165x-Q1 operate from ±2.25-V to ±12-V supplies while maintaining excellent performance. However, some applications do not require equal positive and negative output voltage swing. With the INA165x-Q1, powersupply voltages do not need to be equal. For example, the positive supply can be set to 19 V with the negative supply at –5 V.

## <span id="page-29-1"></span>**10 Layout**

## <span id="page-29-2"></span>**10.1 Layout Guidelines**

For best operational performance of the device, use good printed circuit board (PCB) layout practices, including:

- Connect low-ESR, 1-µF and 0.1-µF ceramic bypass capacitors between each supply pin and ground, placed as close as possible to the device. Connecting bypass capacitors only from V+ to ground is acceptable in single-supply applications. Noise can propagate into analog circuitry through the power pins of this device. The bypass capacitors reduce the coupled noise by providing low-impedance pathways to ground.
- Connect the device REF pins to a low-impedance, low-noise, system reference point (such as an analog ground or the VMID(OUT) pin) with the shortest trace possible.
- Place the external components as close to the device as possible, as shown in [Figure 62](#page-30-1) and [Figure 63.](#page-31-0)
- Use ground pours and planes to shield input signal traces and minimize additional noise introduced into the signal path.
- Keep the length of input traces equal and as short as possible. Route the input traces as a differential pair with as minimal spacing between them as possible.



## <span id="page-30-0"></span>**10.2 Layout Example**



<span id="page-30-1"></span>**Figure 62. Layout Example for a Dual-Supply Line Receiver**



## **Layout Example (continued)**



<span id="page-31-0"></span>**Figure 63. Layout Example for a Single-Supply Line Receiver**



## <span id="page-32-0"></span>**11 Device and Documentation Support**

## <span id="page-32-1"></span>**11.1 Device Support**

#### **11.1.1 Development Support**

### *11.1.1.1 TINA-TI™ (Free Software Download)*

TINA™ is a simple, powerful, and easy-to-use circuit simulation program based on a SPICE engine. TINA-TI is a free, fully-functional version of the TINA software, preloaded with a library of macro models in addition to a range of both passive and active models. TINA-TI provides all the conventional dc, transient, and frequency domain analysis of SPICE, as well as additional design capabilities.

Available as a [free download](http://focus.ti.com/docs/toolsw/folders/print/tina-ti.html) from the WEBENCH® Design Center, TINA-TI offers extensive post-processing capability that allows users to format results in a variety of ways. Virtual instruments offer the ability to select input waveforms and probe circuit nodes, voltages, and waveforms, creating a dynamic quick-start tool.

### **NOTE**

These files require that either the TINA software (from DesignSoft™) or TINA-TI software be installed. Download the free TINA-TI software from the [TINA-TI folder](http://focus.ti.com/docs/toolsw/folders/print/tina-ti.html).

### *11.1.1.2 TI Precision Designs*

TI Precision Designs are available online at <http://www.ti.com/ww/en/analog/precision-designs/>. TI Precision Designs are analog solutions created by TI's precision analog applications experts and offer the theory of operation, component selection, simulation, complete PCB schematic and layout, bill of materials, and measured performance of many useful circuits.

## <span id="page-32-2"></span>**11.2 Documentation Support**

#### **11.2.1 Related Documentation**

For related documentation see the following:

- Texas Instruments, *[Circuit Board Layout Techniques](http://www.ti.com/lit/pdf/sloa089)*
- Texas Instruments, *[On-Chip Thin Film Resistors Enable High-Performance Audio Circuitry](http://www.ti.com/lit/pdf/sboa312)* technical brief

## <span id="page-32-3"></span>**11.3 Receiving Notification of Documentation Updates**

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

## <span id="page-32-4"></span>**11.4 Community Resources**

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of](http://www.ti.com/corp/docs/legal/termsofuse.shtml) [Use.](http://www.ti.com/corp/docs/legal/termsofuse.shtml)

**[TI E2E™ Online Community](http://e2e.ti.com)** *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**[Design Support](http://support.ti.com/)** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

## <span id="page-32-5"></span>**11.5 Trademarks**

SoundPlus, E2E are trademarks of Texas Instruments. TINA-TI is a trademark of Texas Instruments, Inc and DesignSoft, Inc. Bluetooth is a registered trademark of Bluetooth SIG, Inc. TINA, DesignSoft are trademarks of DesignSoft, Inc. All other trademarks are the property of their respective owners.

33

Copyright © 2017–2019, Texas Instruments Incorporated *[Submit Documentation Feedback](http://www.go-dsp.com/forms/techdoc/doc_feedback.htm?litnum=SBOS772C&partnum=INA1650-Q1)*

SBOS772C –AUGUST 2017–REVISED MAY 2019 **[www.ti.com](http://www.ti.com)**



### <span id="page-33-0"></span>**11.6 Electrostatic Discharge Caution**



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## <span id="page-33-1"></span>**11.7 Glossary**

[SLYZ022](http://www.ti.com/lit/pdf/SLYZ022) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## <span id="page-33-2"></span>**12 Mechanical, Packaging, and Orderable Information**

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



www.ti.com 10-Dec-2020

## **PACKAGING INFORMATION**



**(1)** The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures. "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

**(3)** MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**(4)** There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

**(5)** Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

**(6)** Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



# **PACKAGE OPTION ADDENDUM**

#### **OTHER QUALIFIED VERSIONS OF INA1650-Q1, INA1651-Q1 :**

• Catalog: [INA1650,](http://focus.ti.com/docs/prod/folders/print/ina1650.html) [INA1651](http://focus.ti.com/docs/prod/folders/print/ina1651.html)

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

# **PACKAGE MATERIALS INFORMATION**

**TEXAS NSTRUMENTS** 

## **TAPE AND REEL INFORMATION**





## **QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**







# **PACKAGE MATERIALS INFORMATION**

www.ti.com 26-Feb-2022



\*All dimensions are nominal



PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



This drawing is subject to change without notice. **B.** 

 $\hat{\mathbb{C}}$  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

 $\hat{\mathbb{D}}$  Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## **IMPORTANT NOTICE AND DISCLAIMER**

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](https://www.ti.com/legal/termsofsale.html) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2022, Texas Instruments Incorporated